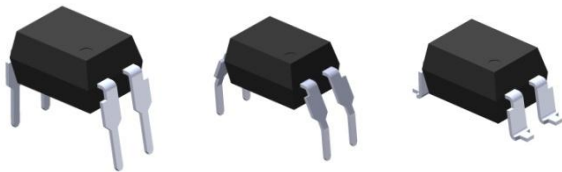
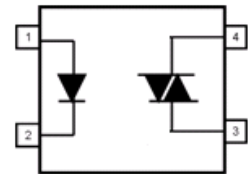


### 4 PIN DIP RANDOM-PHASE TRIAC DRIVER PHOTOCOUPLER ELT302X, ELT305X Series



Schematic



#### Features:

- Peak breakdown voltage
  - 400V: ELT302X
  - 600V: ELT305X
- High isolation voltage between input and output (Viso=5000 V rms )
- Compact dual-in-line package
- Pb free and RoHS compliant.
- UL and cUL approved(No. E214129)
- VDE approved (No. 40028391)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved

#### Pin Configuration

1. Anode
2. Cathode
3. Terminal
4. Terminal

#### Description

The ELT302X and ELT305X series of devices each consist of a GaAs infrared emitting diode optically coupled to a monolithic silicon random phase photo Triac.

They are designed for interfacing between electronic controls and power triacs to control resistive and inductive loads for 115 to 240 VAC operations.

#### Applications

- Solenoid/valve controls
- Lamp ballasts
- Static AC power switch
- Interfacing microprocessors to 115 to 240Vac peripherals
- Incandescent lamp dimmers
- Temperature controls
- Motor controls

**Absolute Maximum Ratings (Ta=25°C)**

Parameter		Symbol	Rating	Unit
Input	Forward current	$I_F$	60	mA
	Reverse voltage	$V_R$	6	V
	Power dissipation	$P_D$	100	mW
	Derating factor (above $T_a = 85^\circ\text{C}$ )		3.8	mW / °C
Output	Off-state Output Terminal Voltage	$V_{DRM}$	ELT302X 400	V
			ELT305X 600	
	Peak Repetitive Surge Current	$I_{TSM}$	1	A
	Power dissipation	$P_C$	300	mW
	Derating factor (above $T_a = 85^\circ\text{C}$ )		7.4	mW/°C
Total power dissipation		$P_{TOT}$	330	mW
Isolation voltage <sup>*1</sup>		$V_{ISO}$	5000	Vrms
Operating temperature		$T_{OPR}$	-55 to 100	°C
Storage temperature		$T_{STG}$	-55 to 125	°C
Soldering Temperature <sup>*2</sup>		$T_{SOL}$	260	°C

Notes:

\*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1 & 2 are shorted together, and pins 3 & 4 are shorted together.

\*2 For 10 seconds

**Electro-Optical Characteristics (Ta=25°C unless specified otherwise)**

**Input**

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Forward Voltage	V <sub>F</sub>	-	1.18	1.5	V	I <sub>F</sub> = 10mA
Reverse Leakage current	I <sub>R</sub>	-	-	10	μA	V <sub>R</sub> = 6V

**Output**

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Peak Blocking Current	I <sub>DRM</sub>	-	-	100	nA	V <sub>DRM</sub> = Rated V <sub>DRM</sub> I <sub>F</sub> = 0mA
Peak On-state Voltage	V <sub>TM</sub>	-	-	2.5	V	I <sub>TM</sub> =100mA peak, I <sub>F</sub> =Rated I <sub>FT</sub>
Critical Rate of Rise off-state Voltage	ELT302X	-	100	-	V/μs	V <sub>PEAK</sub> =Rated V <sub>DRM</sub> , I <sub>F</sub> =0 (Fig. 8)
	ELT305X	1000	-	-		

**Transfer Characteristics**

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
LED Trigger Current	ELT3021 ELT3051	-	-	15	mA	Main terminal Voltage=3V
	ELT3022 ELT3052	-	-	10		
	ELT3023 ELT3053	-	-	5		
Holding Current	I <sub>H</sub>	-	250	-	μA	

\* Typical values at T<sub>a</sub> = 25°C

Typical Electro-Optical Characteristics Curves

Figure 1. Forward Current vs Forward Voltage

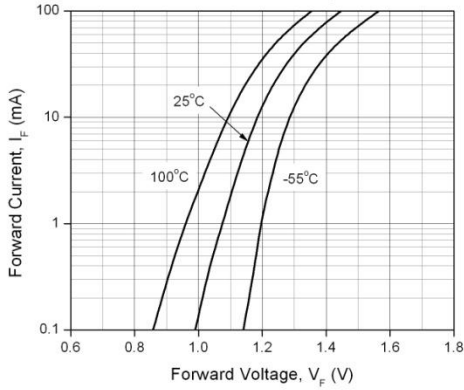


Figure 2. On-State Characteristics

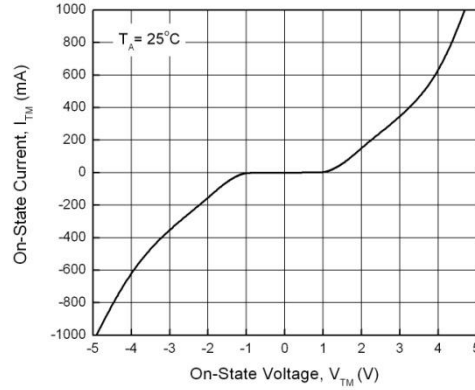


Figure 3. Holding Current vs. Ambient Temperature

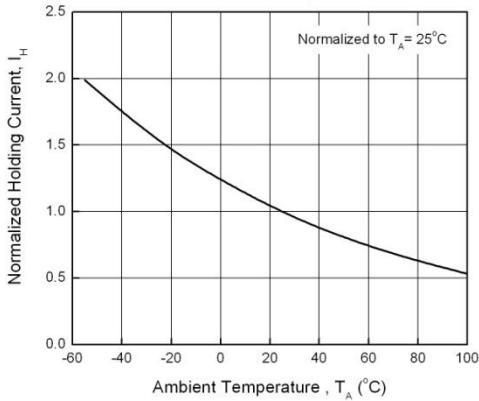


Figure 4. LED Current Required to Trigger vs. LED Pulse Width

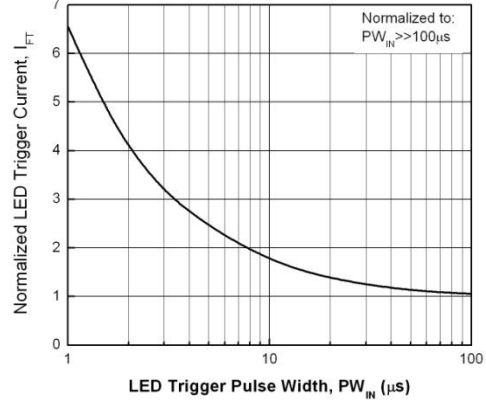


Figure 5. Leakage Current vs. Ambient Temperature

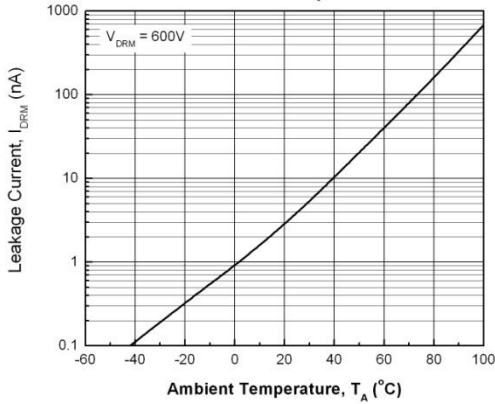


Figure 6. LED Trigger Current vs. Ambient Temperature

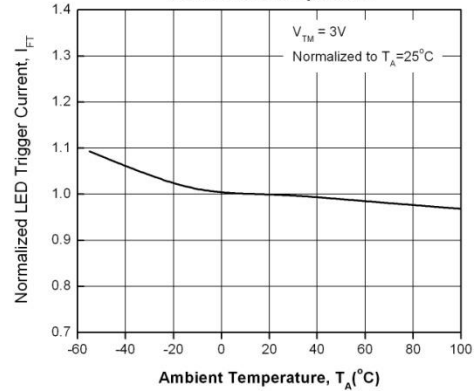


Figure 7. Off-State Output Terminal Voltage vs. Ambient Temperature

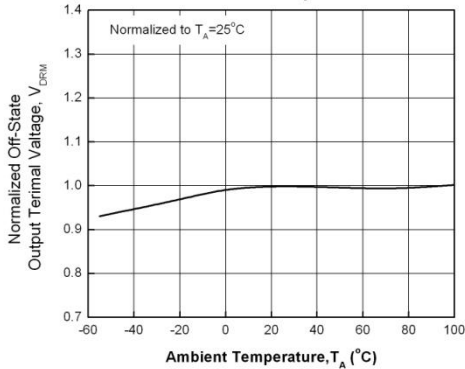
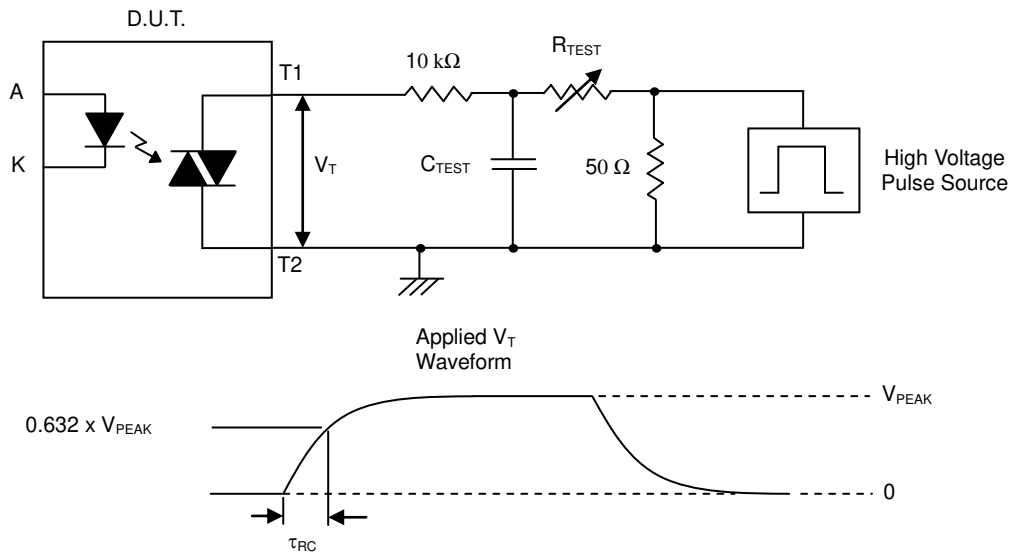


Figure 8. Static dv/dt Test Circuit & Waveform



### Measurement Method

The high voltage pulse is set to the required  $V_{PEAK}$  value and applied to the D.U.T. output side through the RC circuit above. LED current is not applied. The waveform  $V_T$  is monitored using a x100 scope probe. By varying  $R_{TEST}$ , the dv/dt (slope) is increased, until the D.U.T. is observed to trigger (waveform collapses). The dv/dt is then decreased until the D.U.T. stops triggering. At this point,  $\tau_{RC}$  is recorded and the dv/dt calculated.

$$dv/dt = \frac{0.632 \times V_{PEAK}}{\tau_{RC}}$$

For example,  $V_{PEAK} = 400V$  for EL302X series. The dv/dt value is calculated as follows:

$$dv/dt = \frac{0.63 \times 400}{\tau_{RC}} = \frac{252}{\tau_{RC}}$$

## Order Information

### Part Number

**ELT302XY(Z)-V**  
or **ELT305XY(Z)-V**

### Note

X = Part No. (1, 2 or 3)

Y = Lead form option (S, S1, M or none)

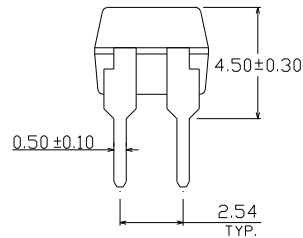
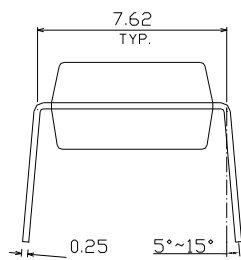
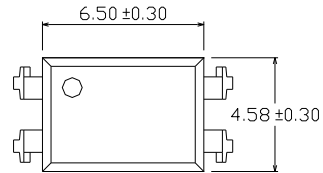
Z = Tape and reel option (TA, TB, TU, TD or none).

V = VDE safety approved (optional)

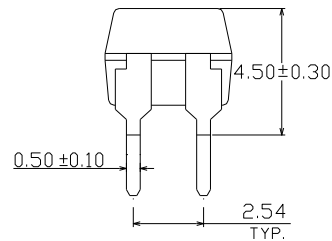
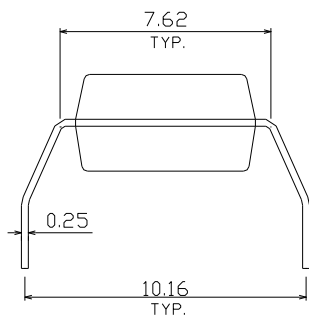
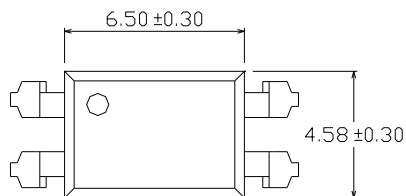
Option	Description	Packing quantity
None	Standard DIP-4	100 units per tube
M	Wide lead bend (0.4 inch spacing)	100 units per tube
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel
S (TB)	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel
S (TU)	Surface mount lead form + TU tape & reel option	1500 units per reel
S (TD)	Surface mount lead form + TD tape & reel option	1500 units per reel
S1 (TU)	Surface mount lead form (low profile) + TU tape & reel option	1500 units per reel
S1 (TD)	Surface mount lead form (low profile) + TD tape & reel option	1500 units per reel

## Package Dimension (Dimensions in mm)

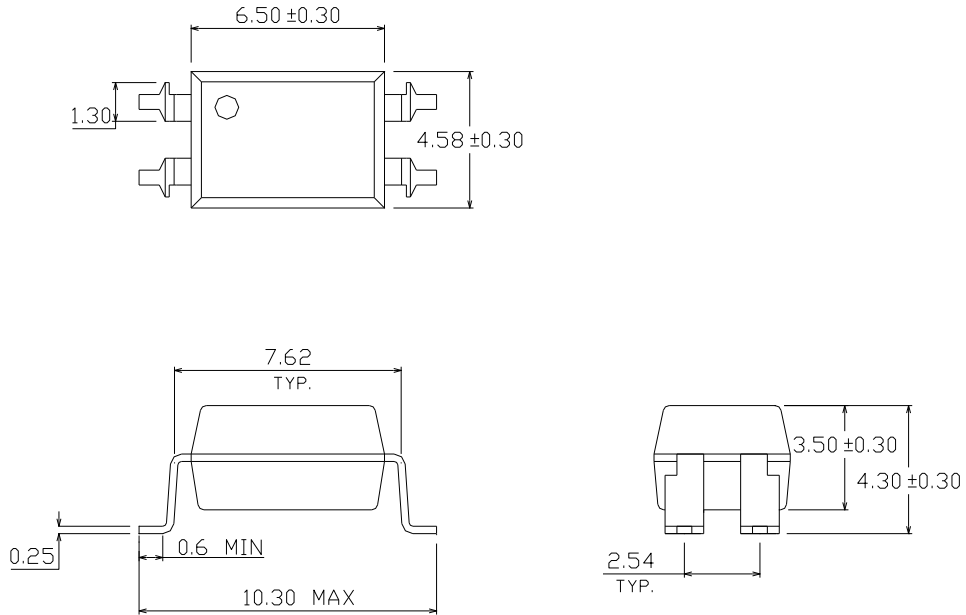
### Standard DIP Type



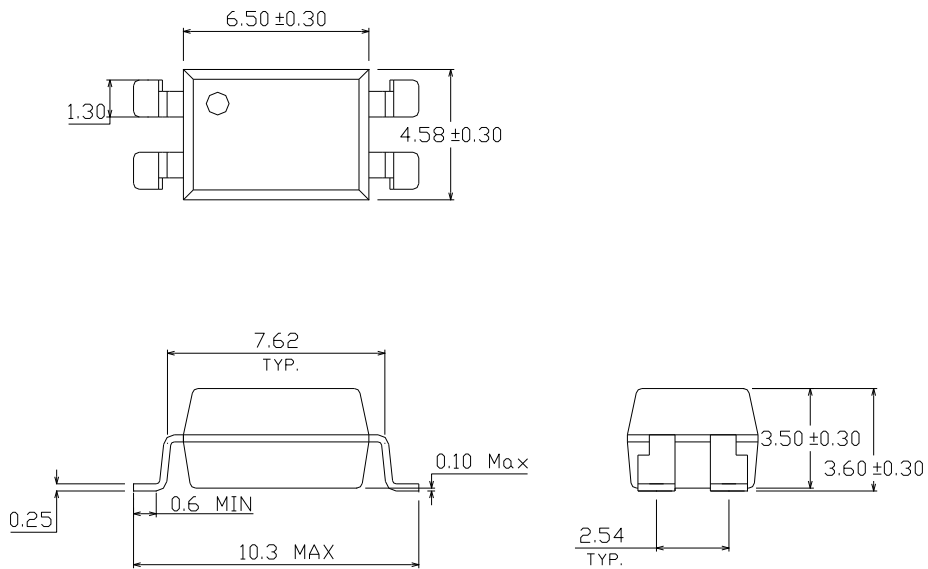
### Option M Type



Option S Type

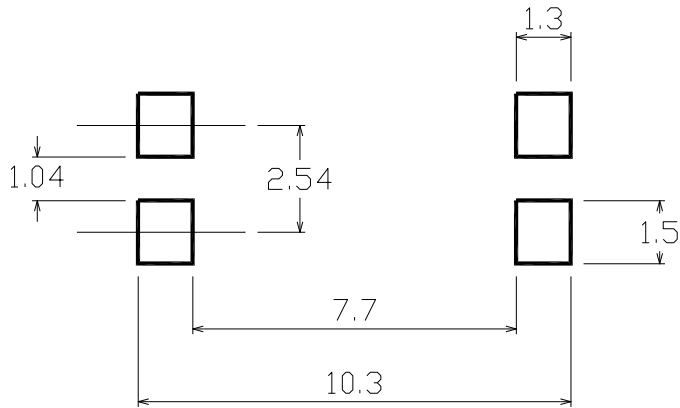


Option S1 Type





**Recommended pad layout for surface mount leadform**



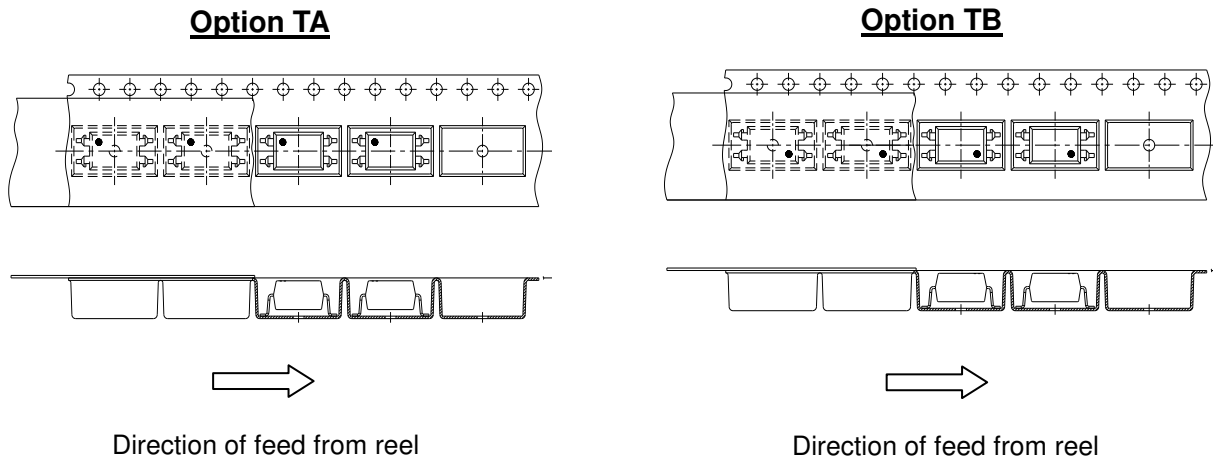
**Device Marking**



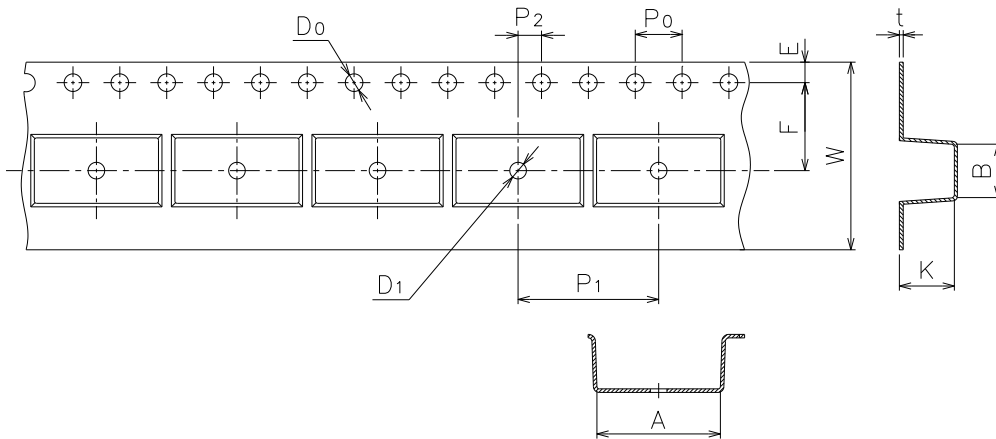
**Notes**

- EL denotes Everlight
- T3053 denotes Device Number
- Y denotes 1 digit Year code
- WW denotes 2 digit Week code
- V denotes VDE option

**Tape & Reel Packing Specifications**



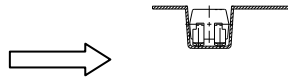
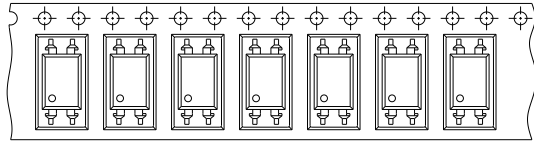
**Tape dimensions**



Dimension No.	A	B	$D_o$	$D_1$	E	F
Dimension (mm)	10.5±0.1	4.65±0.1	1.55±0.1	1.50±0.1	1.75±0.1	7.5±0.1

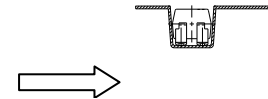
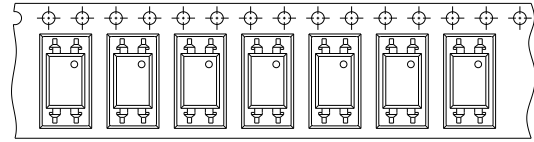
Dimension No.	$P_0$	$P_1$	$P_2$	t	W	K
Dimension (mm)	4.0±0.1	12.0±0.1	2.0±0.1	0.35±0.1	16.0±0.3	4.75±0.1

**Option TD**



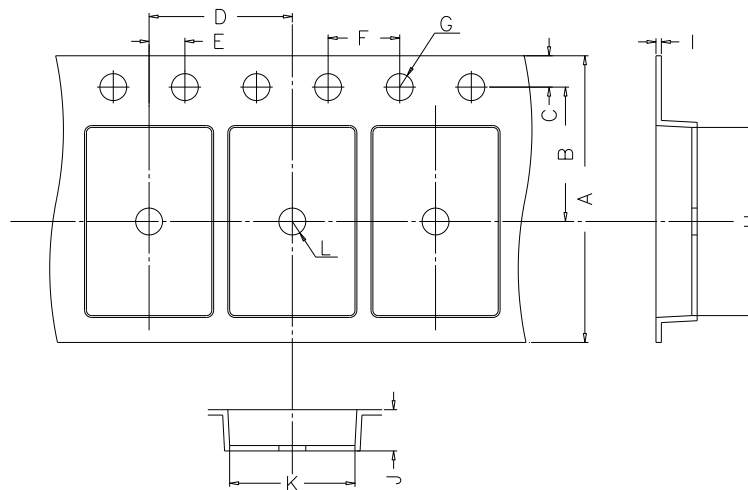
Direction of feed from reel

**Option TU**



Direction of feed from reel

**Tape dimensions**

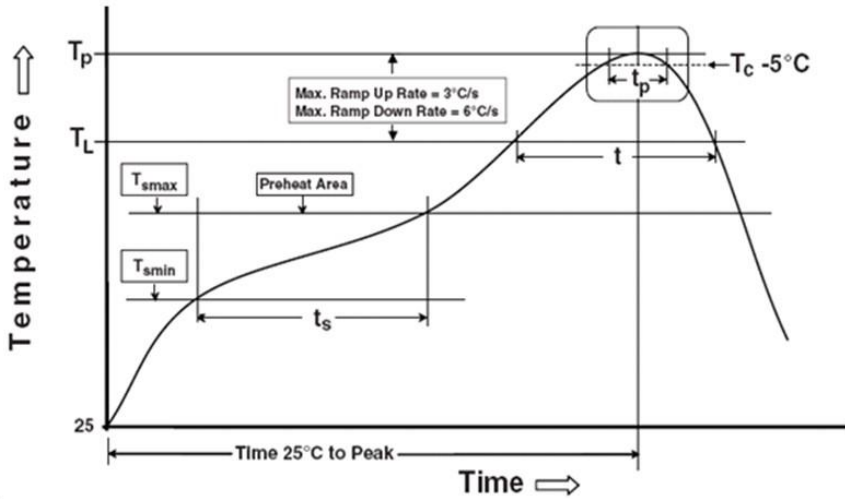


Dimension No.	<b>A</b>	<b>B</b>	<b>C</b>	<b>D</b>	<b>E</b>	<b>F</b>
Dimension(mm)	16.00±0.3	7.5±0.1	1.75±0.1	8.0±0.1	2.0±0.1	4.0±0.1
Dimension No.	<b>G</b>	<b>H</b>	<b>I</b>	<b>J</b>	<b>K</b>	<b>L</b>
Dimension(mm)	1.55±0.05	10.4±0.1	0.4±0.05	4.60±0.1	5.1±0.1	1.55±0.05

**Precautions for Use**

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Reference: IPC/JEDEC J-STD-020D

**Preheat**

Temperature min ( $T_{smin}$ )	150 °C
Temperature max ( $T_{smax}$ )	200°C
Time ( $T_{smin}$ to $T_{smax}$ ) ( $t_s$ )	60-120 seconds
Average ramp-up rate ( $T_{smax}$ to $T_p$ )	3 °C/second max

**Other**

Liquidus Temperature ( $T_L$ )	217 °C
Time above Liquidus Temperature ( $t_L$ )	60-100 sec
Peak Temperature ( $T_p$ )	260°C
Time within 5 °C of Actual Peak Temperature: $T_p - 5^\circ\text{C}$	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature	8 minutes max.
Reflow times	3 times

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